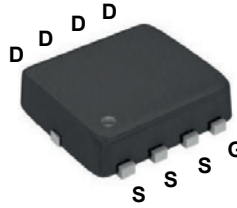
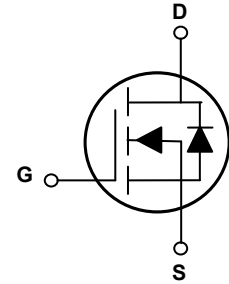


Main Product Characteristics

$V_{(BR)DSS}$	100V
$R_{DS(ON)}$	26m Ω (Max.)
I_D	25A



PPAK3x3



Schematic Diagram

Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



Description

The GSFN26010 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supplies and a wide variety of other applications.

Absolute Maximum Ratings (T_C=25°C unless otherwise specified)

Parameter	Symbol	Max.	Unit
Drain-Source Voltage	V _{DS}	100	V
Gate-to-Source Voltage	V _{GS}	±20	V
Continuous Drain Current, @ Steady-State (T _C =25°C) ¹	I _D	25	A
Continuous Drain Current, @ Steady-State (T _C =100°C)		19	A
Pulsed Drain Current ²	I _{DM}	100	A
Power Dissipation (T _C =25°C)	P _D	35	W
Linear Derating Factor (T _C =25°C)		0.28	W/°C
Single Pulse Avalanche Energy ³	E _{AS}	81	mJ
Junction-to-Case	R _{θJC}	3.57	°C/W
Junction-to-Ambient (PCB Mounted, Steady-State) ⁴	R _{θJA}	62.0	°C/W
Operating Junction and Storage Temperature Range	T _J /T _{STG}	-55 to +150	°C

Electrical Characteristics (T_C=25°C unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
On / Off Characteristics						
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250μA	100	-	-	V
Drain-to-Source Leakage Current	I _{DSS}	V _{DS} =100V, V _{GS} =0V	-	-	1	μA
		T _J =125°C	-	-	20	
Gate-to-Source Forward Leakage	I _{GSS}	V _{GS} =20V	-	-	100	nA
		V _{GS} =-20V	-	-	-100	
Static Drain-to-Source On-Resistance	R _{DS(on)}	V _{GS} =10V, I _D =10A	-	21	26	mΩ
		V _{GS} =6V, I _D =7A	-	28	36	
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	2.1	3.0	3.8	V
Dynamic and Switching Characteristics						
Input Capacitance	C _{iss}	V _{GS} =0V, V _{DS} =50V F=1MHz	-	1355	-	pF
Output Capacitance	C _{oss}		-	171	-	
Reverse Transfer Capacitance	C _{rss}		-	4	-	
Total Gate Charge	Q _g	I _D =33A, V _{DS} =50V, V _{GS} =10V	-	23	-	nC
Gate-to-Source Charge	Q _{gs}		-	10	-	
Gate-to-Drain ("Miller") Charge	Q _{gd}		-	4.9	-	
Turn-on Delay Time	t _{d(on)}	V _{GS} =10V, V _{DS} =50V, I _D =33A, R _{GEN} =2Ω	-	8.4	-	nS
Rise Time	t _r		-	28.5	-	
Turn-Off Delay Time	t _{d(off)}		-	22.4	-	
Fall Time	t _f		-	7.8	-	
Gate Resistance	R _g	F=1MHz	-	2.2	-	Ω
Source-Drain Ratings and Characteristics						
Continuous Source Current (Body Diode)	I _S	MOSFET symbol showing the integral reverse p-n junction diode.	-	-	45	A
Pulsed Source Current (Body Diode)	I _{SM}		-	-	180	A
Diode Forward Voltage	V _{SD}	I _S =45A, V _{GS} =0V	-	1.0	1.2	V
Reverse Recovery Time	T _{rr}	T _J =25°C, I _F =45A, di/dt=100A/μs	-	56	-	nS
Reverse Recovery Charge	Q _{rr}		-	0.09	-	uc

Notes:

1. Pulse test: pulse width ≤300us, duty cycle ≤2%.
2. Repetitive rating; pulse width limited by max. junction temperature.
3. L=0.5mH, V_{DD}=80V, I_{AS}=18A, R_G=25Ω, T_J=25°C.
4. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch.

Typical Electrical and Thermal Characteristic Curves

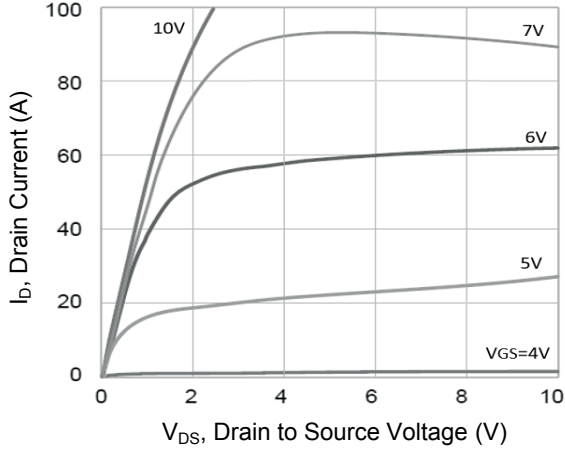


Figure 1. Output Characteristics

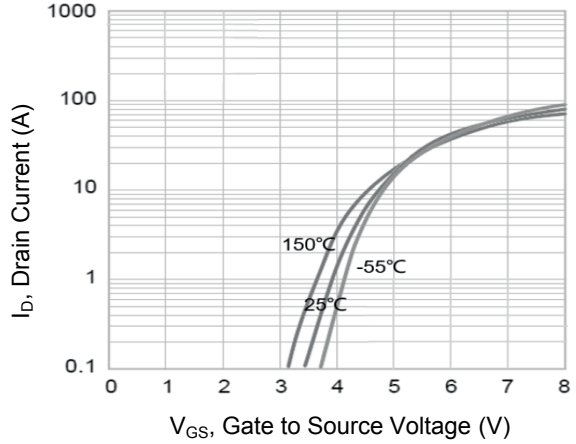


Figure 2. Transfer Characteristics

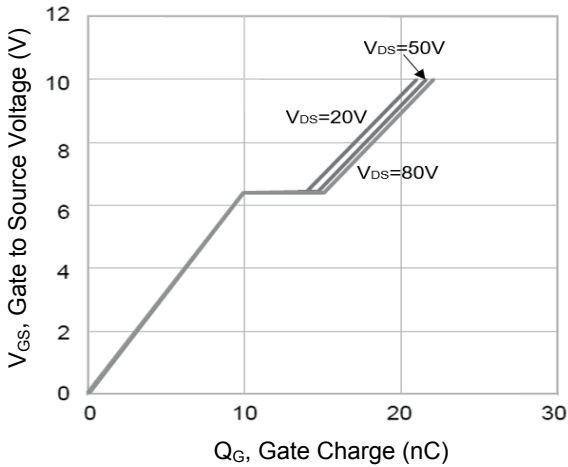


Figure 3. Gate Charge

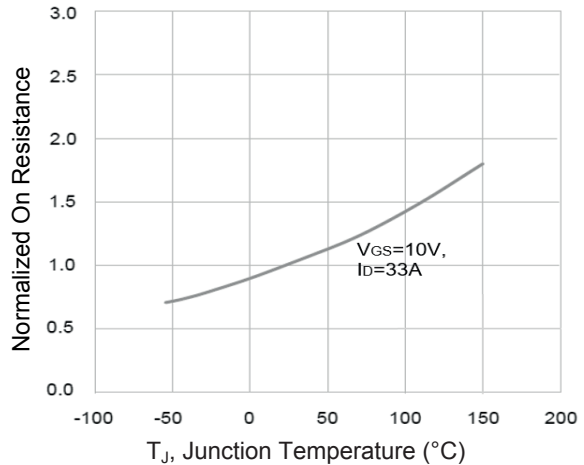


Figure 4. Normalized $R_{DS(ON)}$ Vs. T_J

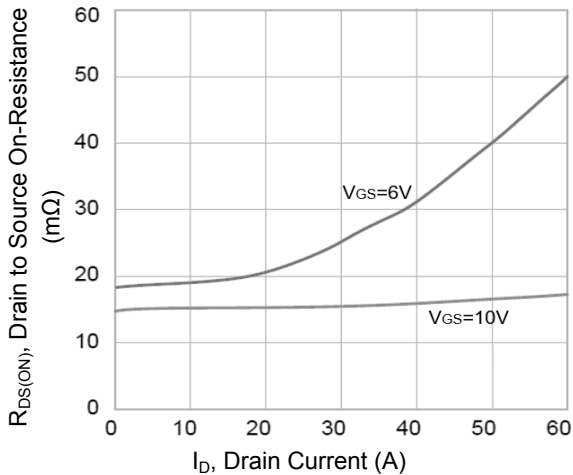


Figure 5. $R_{DS(ON)}$ Vs. Drain Current

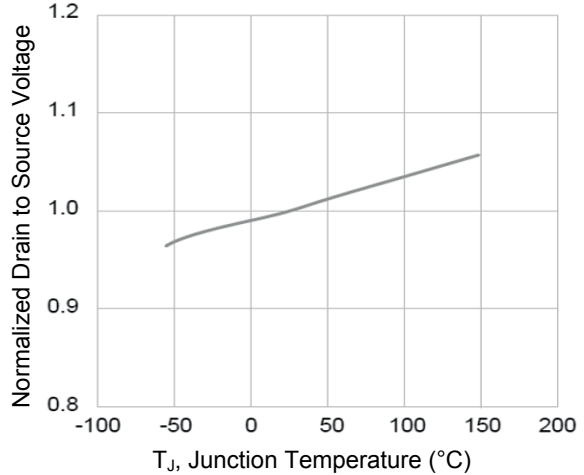


Figure 6. Normalized BV_{DSS} Vs. T_J

Typical Electrical and Thermal Characteristic Curves

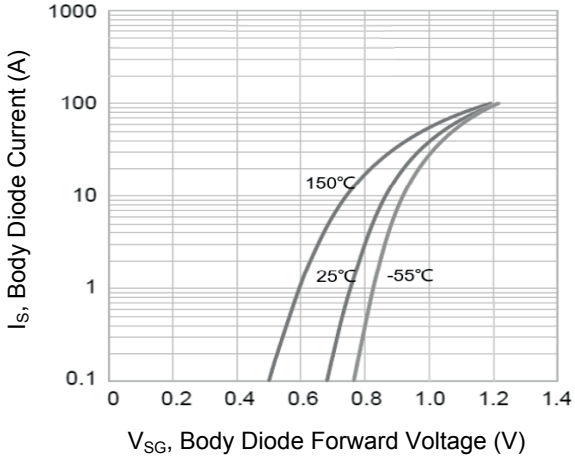


Figure 7. Body Diode Characteristics

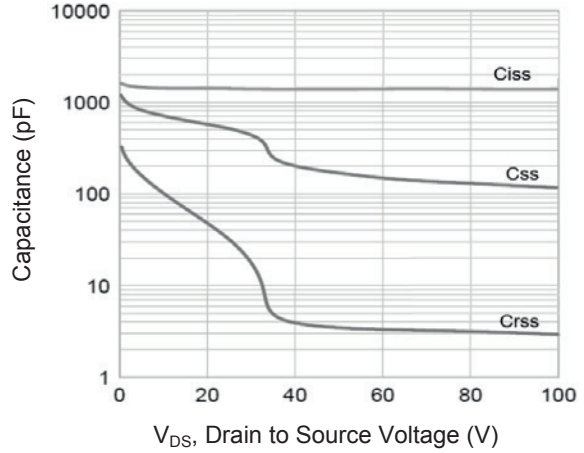


Figure 8. Capacitance Characteristics

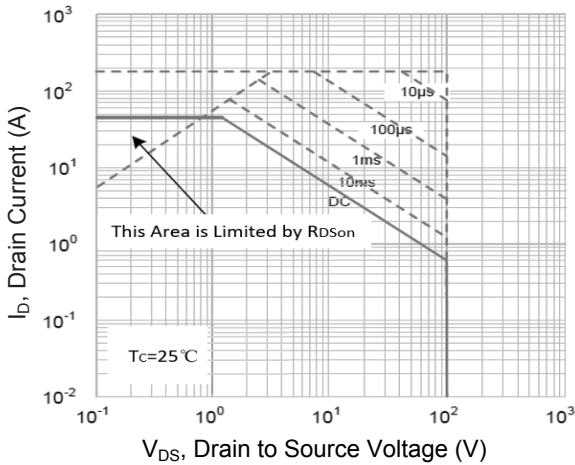
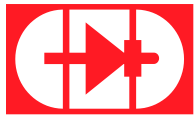
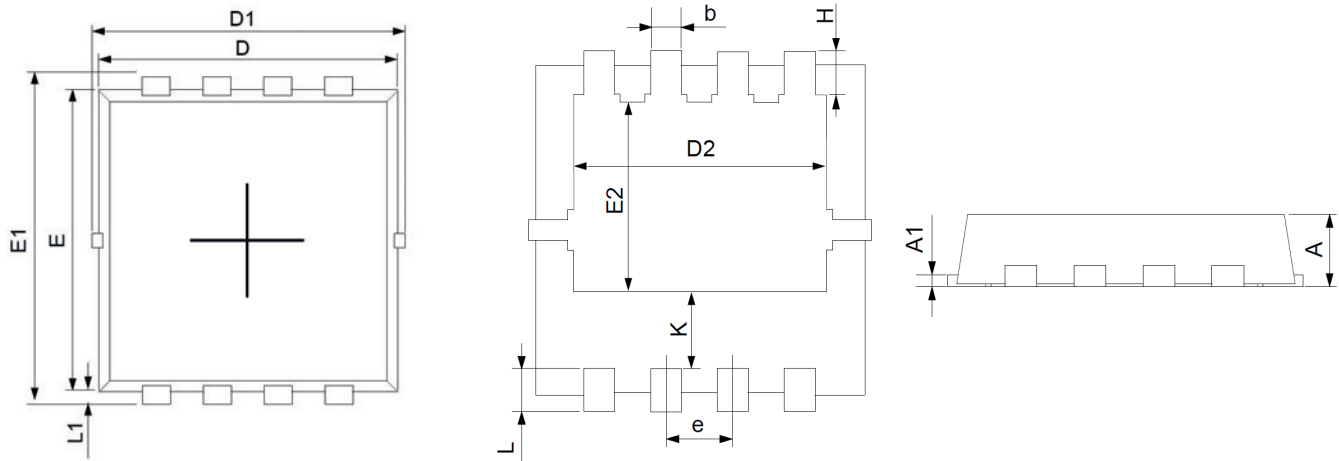


Figure 9. Safe Operation Area



Package Outline Dimensions (PPAK3x3)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.70	0.90	0.028	0.035
A1	0.14	0.20	0.006	0.008
D	3.05	3.25	0.120	0.128
E	2.90	3.10	0.114	0.122
D1	3.10	3.50	0.122	0.138
D2	2.35	2.50	0.093	0.098
E1	3.10	3.50	0.122	0.138
E2	1.64	1.84	0.065	0.072
b	0.25	0.35	0.010	0.014
K	0.59	0.79	0.023	0.031
e	0.55	0.75	0.022	0.030
L	0.25	0.55	0.010	0.022
L1	0.10	0.20	0.004	0.008
H	0.32	0.52	0.013	0.020

Order Information

Device	Package	Marking	Carrier	Quantity
GSFN26010	PPAK3x3	N26010	Tape & Reel	5,000pcs / Reel

For more information, please contact us at: inquiry@goodarksemi.com